

MOSFET

OptiMOS[™] 5 Power-Transistor, 30 V

Features

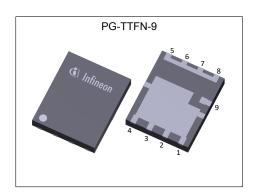
- N-channel, logic level
- Very low on-resistance R_{DS(on)}
 Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

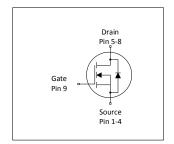
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

i dia i di d							
Parameter	Value	Unit					
V _{DS}	30	V					
R _{DS(on),max}	0.35	mΩ					
I _D	700	Α					
Qoss	95	nC					
Q _G	91	nC					











Type / Ordering Code	Package	Marking	Related Links
IQDH35N03LM5CG	PG-TTFN-9	H3503LC	-

OptiMOS[™] 5 Power-Transistor, 30 V



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1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Damanastan	Oh a l	Values			ļ., .,	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	- - -	700 443 414 66	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 °C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	2800	Α	<i>T</i> _C =25 °C
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	1200	mJ	$I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	278 2.5	W	T _C =25 °C T _A =25 °C, R _{thJA} =50 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	-

2 Thermal characteristics

Table 3 Thermal characteristics

Darameter	Symbol	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	0.45	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area ²⁾	R _{thJA}	-	-	50	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

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3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Parameter	0		Values	11		
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	30	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	1.2	1.6	2.0	V	V _{DS} =V _{GS} , I _D =1460 μA
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	V _{DS} =24 V, V _{GS} =0 V, T _j =25 °C V _{DS} =24 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	0.31 0.36	0.35 0.4	mΩ	V _{GS} =10 V, I _D =50 A V _{GS} =4.5 V, I _D =50 A
Gate resistance ¹⁾	R _G	-	0.47	-	Ω	-
Transconductance	g fs	265	530	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 50 A$

Table 5 **Dynamic characteristics**

Parameter	Or make all	Values				N
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	C _{iss}	-	14000	18000	pF	V _{GS} =0 V, V _{DS} =15 V, f=1 MHz
Output capacitance ¹⁾	Coss	-	3300	4300	pF	V _{GS} =0 V, V _{DS} =15 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	270	470	pF	V _{GS} =0 V, V _{DS} =15 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	12	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	5	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	70	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	14	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω

Gate charge characteristics²⁾ Table 6

Parameter	Crossbal	Values			l lmi4	Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	31	-	nC	V_{DD} =15 V, I_{D} =50 A, V_{GS} =0 to 4.5 V
Gate charge at threshold	Q _{g(th)}	-	22	-	nC	V_{DD} =15 V, I_{D} =50 A, V_{GS} =0 to 4.5 V
Gate to drain charge ¹⁾	Q_{gd}	-	18	27	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V
Switching charge	Q _{sw}	-	27	-	nC	V_{DD} =15 V, I_{D} =50 A, V_{GS} =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	91	114	nC	V_{DD} =15 V, I_{D} =50 A, V_{GS} =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	2.3	-	V	V_{DD} =15 V, I_{D} =50 A, V_{GS} =0 to 4.5 V
Gate charge total	Qg	-	197	-	nC	V _{DD} =15 V, I _D =50 A, V _{GS} =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	86	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 4.5 V
Output charge ¹⁾	Qoss	-	95	126	nC	V _{DS} =15 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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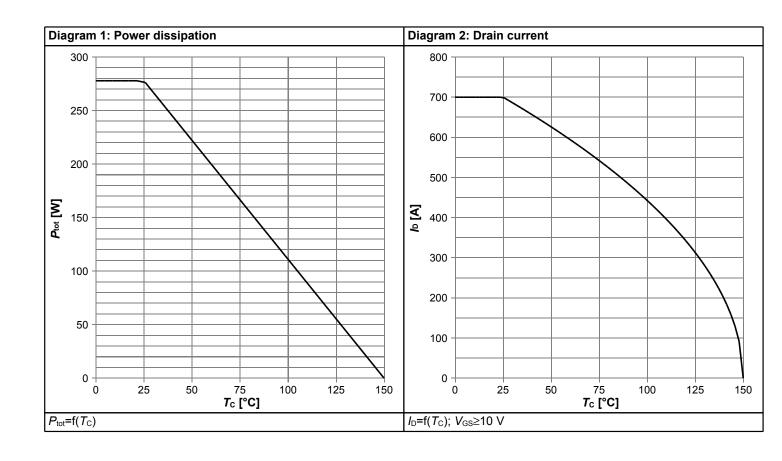


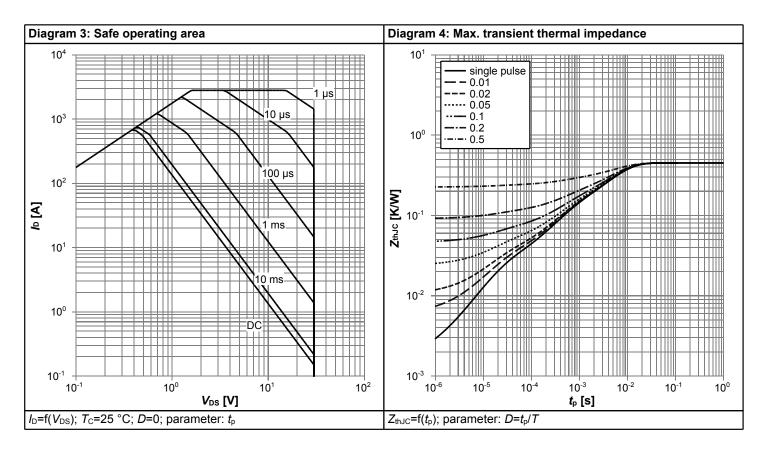
Table 7 Reverse diode

Parameter	Cumbal		Values			Nata (Tast Oan dition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	236	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	2800	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.72	1.0	V	V _{GS} =0 V, I _F =50 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	49	98	ns	V _R =15 V, I _F =25 A, di _F /dt=100 A/μs
Reverse recovery charge ¹⁾	Qrr	-	64	128	nC	V _R =15 V, I _F =25 A, di _F /dt=100 A/μs

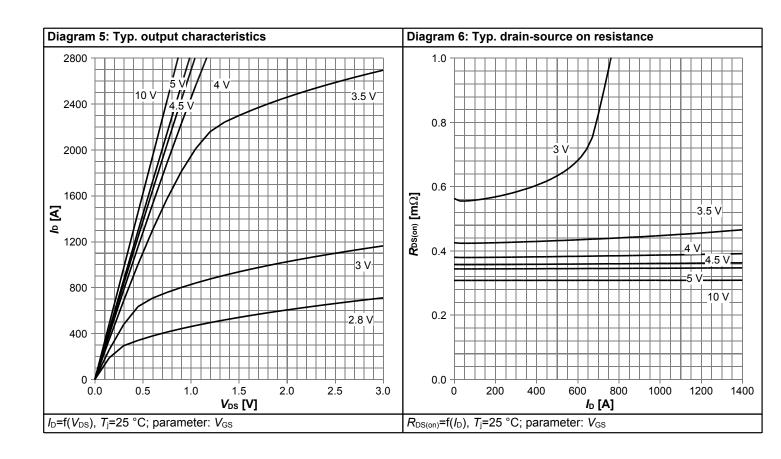


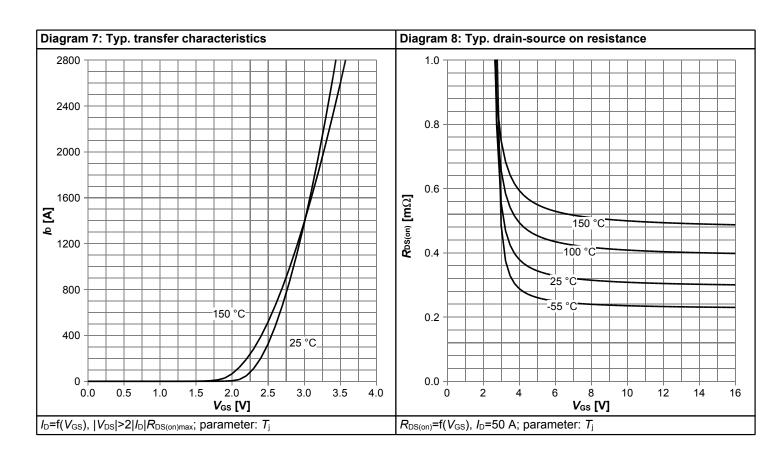
4 Electrical characteristics diagrams



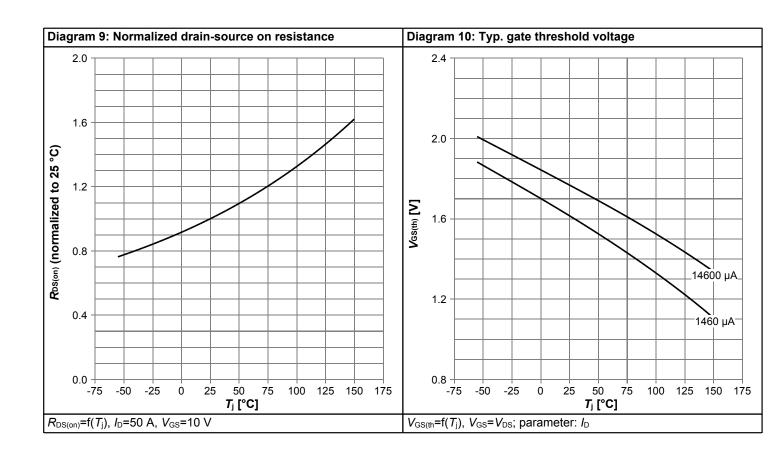


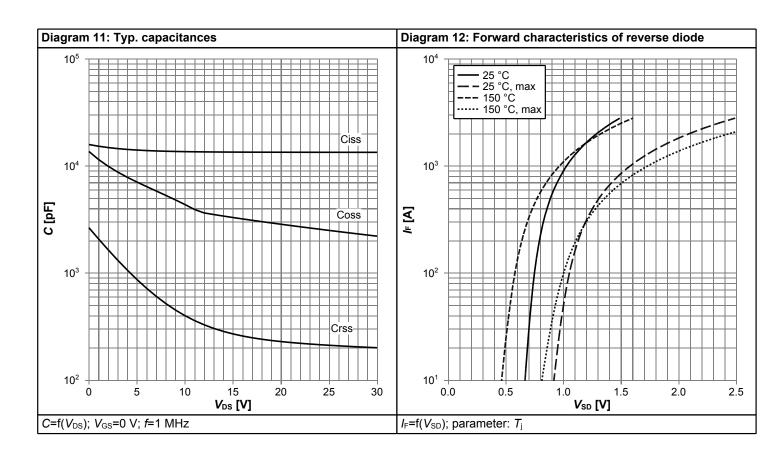




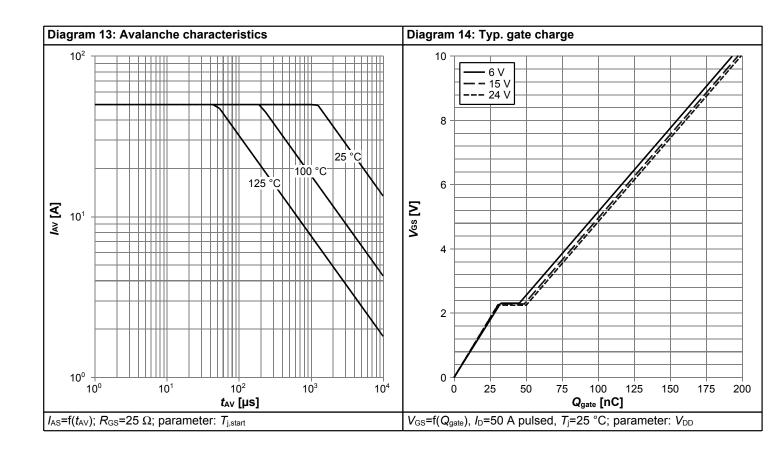


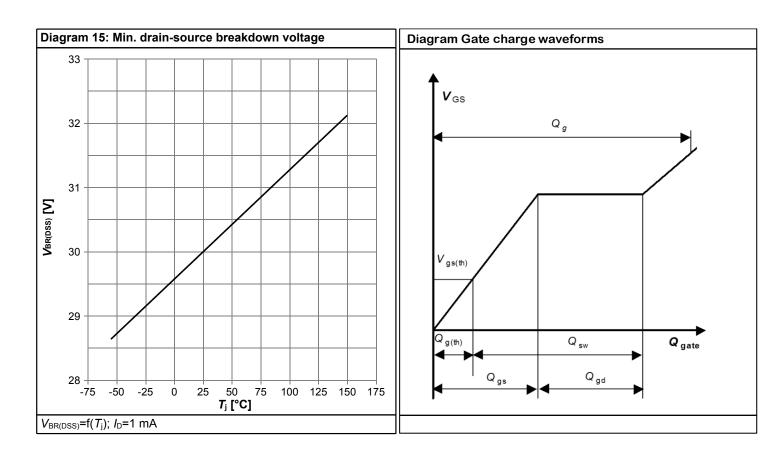














5 Package Outlines

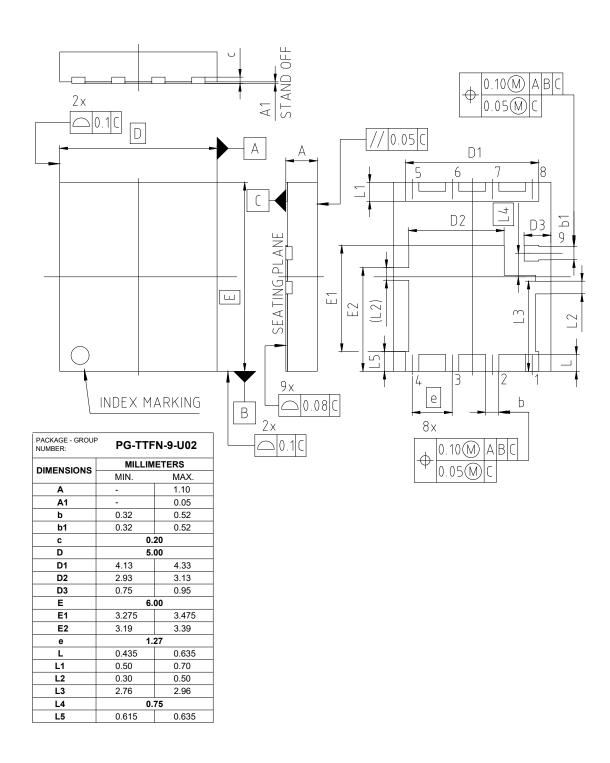


Figure 1 Outline PG-TTFN-9, dimensions in mm

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Revision History

IQDH35N03LM5CG

Revision: 2023-03-29, Rev. 2.1

Previous Revision

r revious revision							
Revision	sion Date Subjects (major changes since last revision)						
2.0	2023-03-17	Release of final version					
2.1	2023-03-29	Update RG, ext for switching times					

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